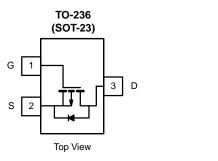


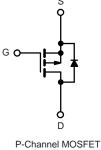
RoHS COMPLIANT HALOGEN

FREE

P-Channel 30 V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	R _{DS(on)} (Ω) Typ.	I _D (A) ^a	Q _g (Typ.)		
	0.046 at V _{GS} = - 10 V	- 5.6			
- 30	0.049 at V _{GS} = - 6 V	- 5	11.4 nC		
	0.054 at V _{GS} = - 4.5 V	-4.5			





FEATURES

- TrenchFET[®] Power MOSFET
- 100 % R_g Tested

APPLICATIONS

- For Mobile Computing
 - Load Switch - Notebook Adaptor Switch
 - DC/DC Converter

ABSOLUTE MAXIMUM RATIN	IGS (T _A = 25 °C	, unless otherwi	se noted)		
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	- 30	V	
Gate-Source Voltage		V _{GS}	± 20	V	
	T _C = 25 °C		- 5.6		
Constitutions Drain Constant (T. 450 °C)	T _C = 70 °C		- 5.1		
Continuous Drain Current ($T_J = 150 \ ^{\circ}C$)	T _A = 25 °C		- 5.4 ^{b,c}		
	T _A = 70 °C		- 4.3 ^{b,c}	A	
Pulsed Drain Current (t = 100 μs)		I _{DM}	- 18		
Continuus Courses Drain Diada Coursent	T _C = 25 °C		- 2.1		
Continous Source-Drain Diode Current	T _A = 25 °C	I _S	- 1 ^{b,c}		
	T _C = 25 °C		2.5		
Maximum Davida Disainatian	T _C = 70 °C		1.6	10/	
Maximum Power Dissipation	T _A = 25 °C	P _D	1.25 ^{b,c}	W	
	T _A = 70 °C	1	0.8 ^{b,c}		
Operating Junction and Storage Temperatur	e Range	T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS

	Symbol	Typical	Maximum	Unit	
$t \le 5 s$	R _{thJA}	75	100	°C/W	
Steady State	R _{thJF}	40	50	0/11	
		$t \le 5 \text{ s}$ R_{thJA}	t \leq 5 s R _{thJA} 75	t \leq 5 s R _{thJA} 75 100	

Notes:

a. Based on T_C = 25 °C.
b. Surface mounted on 1" x 1" FR4 board.

c. t = 5 s.

d. Maximum under steady state conditions is 166 °C/W.

AP2303GN

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static				•		•	
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = - 250 μA	- 30			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	1 250.04		- 19		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	- I _D = - 250 μΑ		4			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$	- 0.5		- 2.0	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zana Osta Malta na Daria Osmanl	1	V _{DS} = - 30 V, V _{GS} = 0 V			- 1	μA	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 \text{ °C}$			- 5		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le$ - 5 V, V_{GS} = - 10 V	- 2.5			Α	
		V _{GS} =- 10 V, I _D = - 4.4 A		0.046	0.055		
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} =- 6 V, I _D = - 4 A		0.049	0.058	β Ω	
		V _{GS} =- 4.5 V, I _D = - 3.6 A		0.054	0.063		
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 3.4 A		18		S	
Dynamic ^b		<u> </u>		<u>I</u>	ļ		
Input Capacitance	C _{iss}			1295		pF	
Output Capacitance	C _{oss}	V _{DS} = - 15 V, V _{GS} = 0 V, f = 1 MHz		150			
Reverse Transfer Capacitance	C _{rss}			130			
		V _{DS} = - 15 V, V _{GS} = - 10 V, I _D = - 5.4 A		24	36		
Total Gate Charge	Qg			11.4	17		
Gate-Source Charge	Q _{gs}	V _{DS} = - 15 V, V _{GS} = - 4.5 V, I _D = - 5.4 A		3.4		– nC	
Gate-Drain Charge	Q _{gd}			3.8			
Gate Resistance	R _g	f = 1 MHz	1.5	7.7	15.4	Ω	
Turn-On Delay Time	t _{d(on)}			13	20		
Rise Time	t _r	t_r $V_{DD} = -15 V, R_L = 3.5 \Omega$		4	8	-	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ - 4.3 A, V_{GEN} = - 10 V, R_g = 1 Ω		38	57		
Fall Time	t _f	1		6	12	1	
Turn-On Delay Time	t _{d(on)}			28	42	ns	
Rise Time	t _r	V_{DD} = - 15 V, R _L = 3.5 Ω		16	24	-	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ - 4.3 A, V_{GEN} = - 4.5 V, R_g = 1 Ω		30	45		
Fall Time	t _f	1		10	20		
Drain-Source Body Diode Characteristic	s	· · · · · · · · · · · · · · · · · · ·		1			
Continuous Source-Drain Diode Current	۱ _S	T _C = 25 °C			- 2.1		
Pulse Diode Forward Current (t = $100 \mu s$)	I _{SM}				- 80	A	
Body Diode Voltage	V _{SD}	I _S = - 4.3 A, V _{GS} = 0 V		- 0.8	- 1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			15	23	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			7	14	nC	
Reverse Recovery Fall Time	ta	I _F = - 4.3 A, dl/dt = 100 A/μs, T _J = 25 °C		8		ns	
Reverse Recovery Rise Time	t _b	1 1		7			

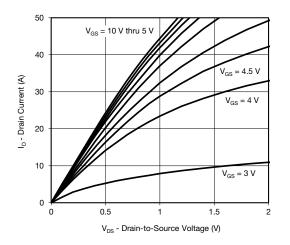
a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

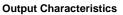
b. Guaranteed by design, not subject to production testing.

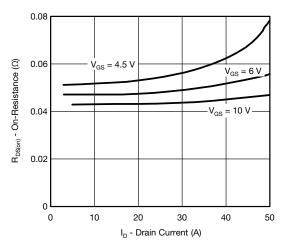
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



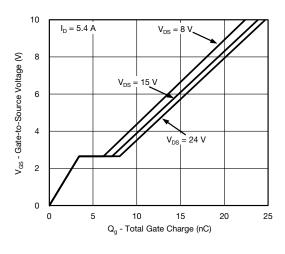




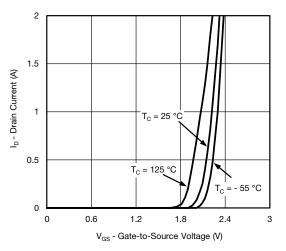




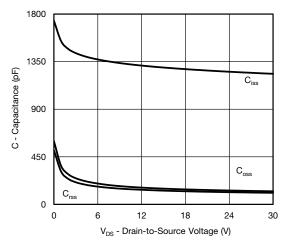
On-Resistance vs. Drain Current



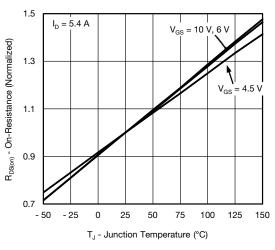
Gate Charge



Transfer Characteristics

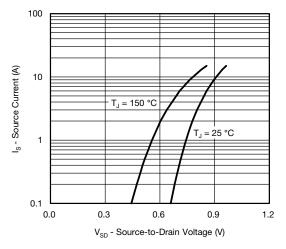




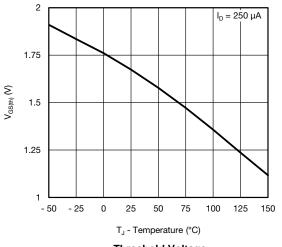


On-Resistance vs. Junction Temperature

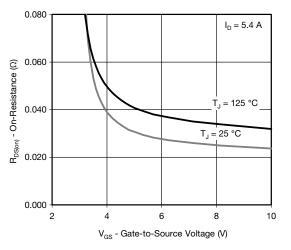




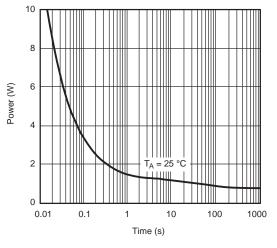
Source-Drain Diode Forward Voltage



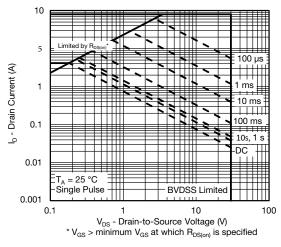
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage

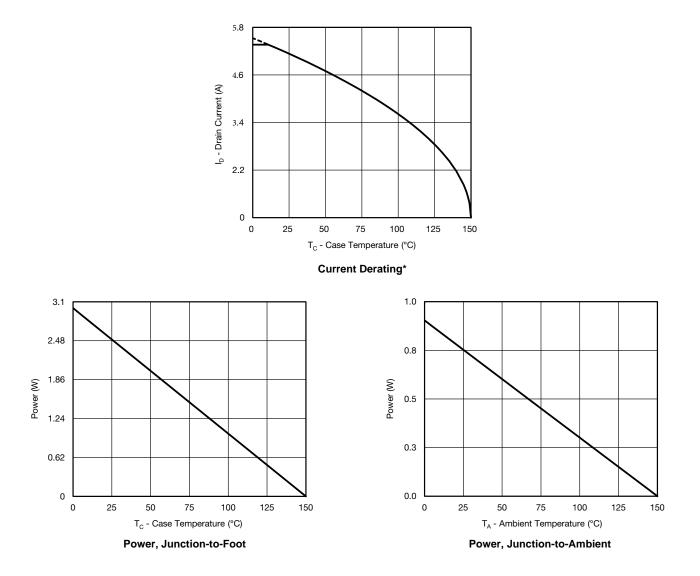


Single Pulse Power (Junction-to-Ambient)



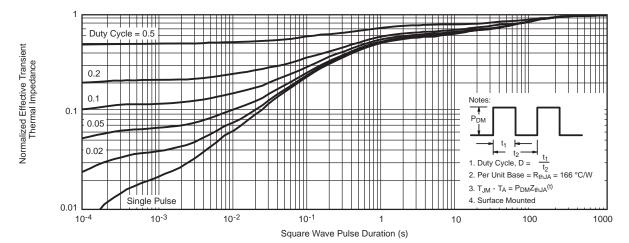
Safe Operating Area, Junction-to-Ambient



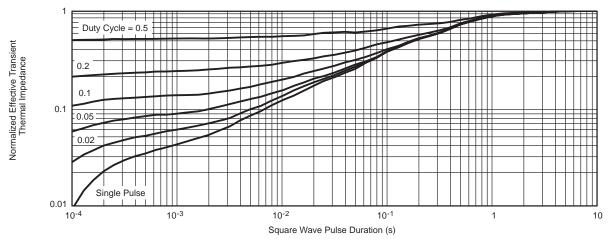


* The power dissipation P_D is based on $T_{J(max.)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





Normalized Thermal Transient Impedance, Junction-to-Ambient

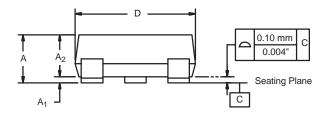


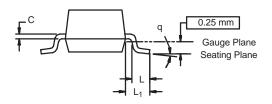
Normalized Thermal Transient Impedance, Junction-to-Foot



SOT-23 (TO-236): 3-LEAD



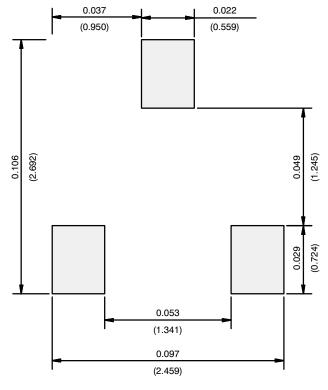




Dim -	MILLIM	IETERS	INCHES		
	Min	Max	Min	Max	
Α	0.89	1.12	0.035	0.044	
A ₁	0.01	0.10	0.0004	0.004	
A ₂	0.88	1.02	0.0346	0.040	
b	0.35	0.50	0.014	0.020	
C	0.085	0.18	0.003	0.007	
D	2.80	3.04	0.110	0.120	
E	2.10	2.64	0.083	0.104	
E ₁	1.20	1.40	0.047	0.055	
е	0.95 BSC		0.0374 Ref		
e ₁	1.90 BSC		0.0748 Ref		
L	0.40	0.60	0.016	0.024	
L ₁	0.64 Ref		0.025 Ref		
S	0.50 Ref		0.020 Ref		
q	3°	8°	3°	8°	



RECOMMENDED MINIMUM PADS FOR SOT-23



Recommended Minimum Pads Dimensions in Inches/(mm)



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